TOSHIBA Field Effect Transistor Silicon N Channel MOS Type ($L^2-\pi$ -MOSV)

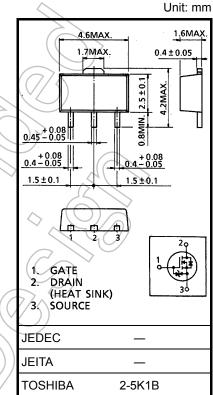
2SK2615

DC-DC Converter, Relay Drive and Motor Drive Applications

- Low drain-source ON resistance $: RDS (ON) = 0.23 \Omega (typ.)$
- High forward transfer admittance $|Y_{fs}| = 2.0 \text{ S (typ.)}$
- Low leakage current $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 60 \ V)$
- Enhancement mode $V_{th} = 0.8 \text{ to } 2.0 \text{ V} (V_{DS} = 10 \text{ V}, \text{ ID} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	$\langle \rangle$
Drain-source voltage		V _{DSS}	60	$\langle \psi \rangle$	
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	60	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	۱ _D	2	A	
	Pulse (Note 1)	I _{DP}	6	~	(
Drain power dissipation		PD	0.5	W	
Drain power dissipation (Note 2)		PD	1.5	$\langle \langle w \rangle$	
Channel temperature		T _{ch}	150	<u> </u>	
Storage temperature range		Tstg	-55 to 150	°C	\sim



Weight: 0.05 g (typ.)

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Mounted on a ceramic substrate (25.4 mm × 25.4 mm × 0.8 mm)

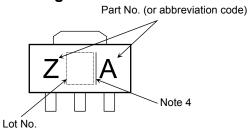
Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	Rth (ch-a)	250	°C / W

This transistor is an electrostatic-sensitive device. Please handle with caution.

Marking



Note 4: A line to the right of a Lot No. identifies the indication of product Labels. Without a line: [[Pb]]/INCLUDES > MCV

With a line: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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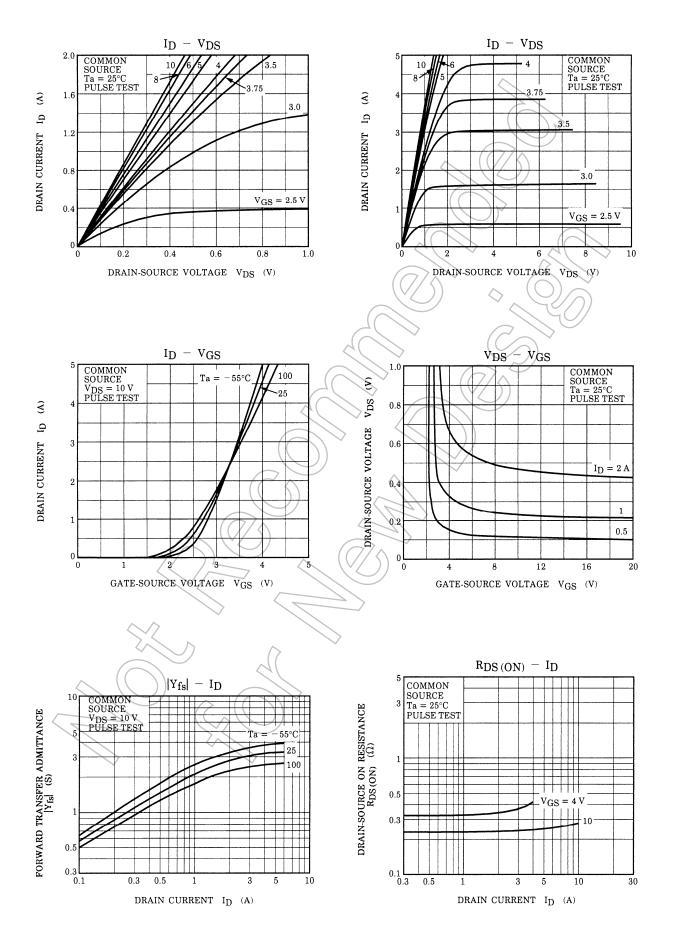
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μA	
Drain cut-off cu	rrent	IDSS	V _{DS} = 60 V, V _{GS} = 0 V		_	100	μA	
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	60	_	_	V	
Gate threshold v	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	_	2.0	V	
Drain-source ON resistance		R _{DS (ON)}	VGS = 4 V, ID = 1 A	K	0.33	0.44	Ω	
			VGS = 10 V, ID = 1 A	K	0.23	0.30		
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1 A	1.0	2.0		S	
Input capacitance		C _{iss}			150			
Reverse transfer capacitance		C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	25	_	pF	
Output capacitance		C _{oss}		_	70			
Switching time	Rise time	tr	$V_{GS} \stackrel{10V}{_{0V}} \prod_{V_{GS}} \stackrel{I_{D}=1A}{_{V_{out}}} V_{out}$	-	25		ns	
	Turn-on time	t _{on}		C V	30) —		
	Fall time	t _f	$= 30\Omega$	$\overline{\mathcal{A}}$	50	_		
	Turn-off time	t _{off}	Duty $\leq 1\%$, t _w =10µs		150	_		
Total gate charge (gate-source plus gate-drain)		Qg		_	6.0	_		
Gate-source charge		Q _{gs}	$V_{DD} \approx 48 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 2 \text{ A}$		4.6	_	nC	
Gate-drain ("miller") Charge		Q _{gd}		_	1.4	—		

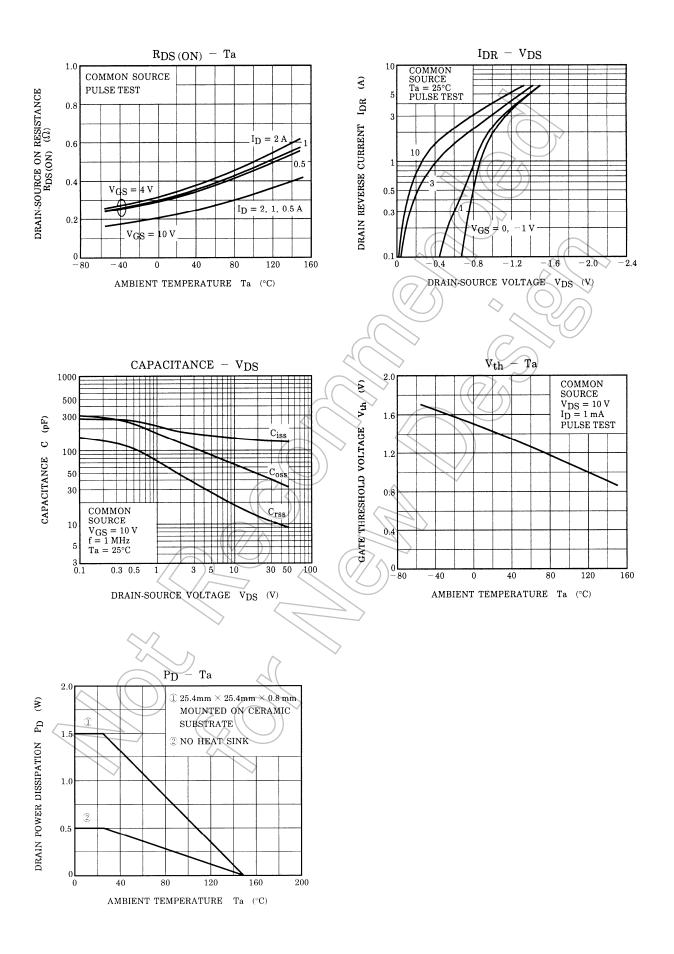
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR		_	_	2	А
Pulse drain reverse current (Note 1)	I _{DRP}	-	_		6	А
Forward voltage (diode)	VDSF	I _{DR} = 2 A, V _{GS} = 0 V	_	-	-1.5	V
Reverse recovery time	trr	I _{DR} = 2 A, V _{GS} = 0 V		100		ns
Reverse recovery charge	Q _{rr}	dl _{DR} / dt = 50 A / μs	_	40	_	nC

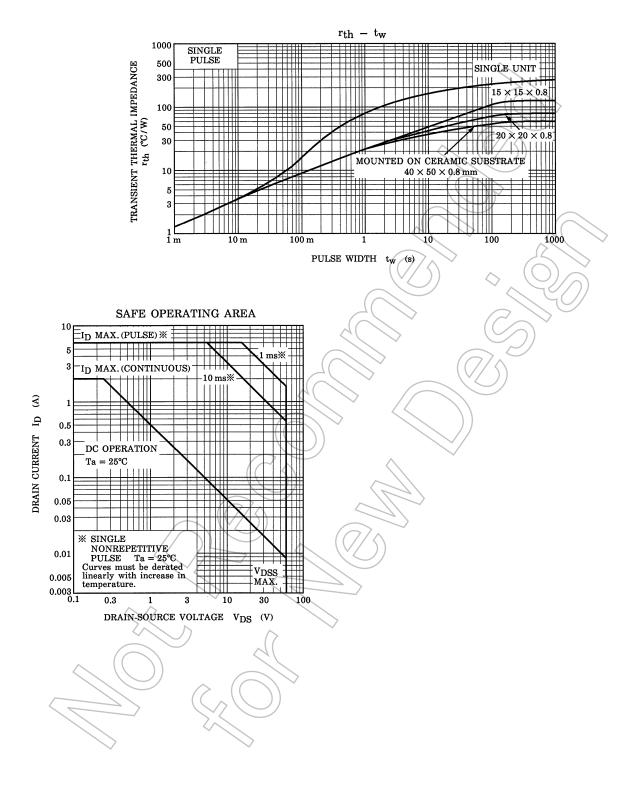
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